U.S. PTO 29/311424 03/12/2009 03-24-2009

103553660

Form PTO-1595 (Rev. 11/08)		
OMB No. 0651-0027 (exp. 12/31/2008)		
	RECORDATION FORM COVER SHEET	
	DATENTS ONLY	

PAIENIS	ONLY	
To the Director of the U.S. Patent and Trademark Office: Please	record the attached documents or the new address(es) below.	
Name of conveying party(ies):	2. Name and address of receiving party(ies)	
Young A. Lee (02/24/2009), Hee Su Yang (02/24/2009), and Kyong Tae Han (02/24/2009)	Name: LG Electronics Inc.	
Additional name(s) of conveying party(les) attached?	Internal Address:  Street Address:	
3. Nature of conveyance/Execution Date(s):		
Execution Date(s): in parentheses after inventor name  X Assignment Merger Change of Name	20 Yeouido-dong, Yeongdeungpo-gu	
Security Agreement Joint Research Agreement	City: Seoul	
Government Interest Assignment	State:	
Executive Order 9424, Confirmatory License		
Other	Country: Republic of Korea Zip: 150-721  Additional name(s) & address(es) Yes X No attached?	
Additional numbers attached?  5. Name and address to whom correspondence concerning document should be mailed:  Name: Robert J. Gaybrick  MORGAN LEWIS & BOCKIUS LLP  Internal Address: Atty. Dkt.: 054358-7058US  Street Address: 1111 Pennsylvania Ave NW	Yes X No  6. Total number of applications and patents involved:  7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00  X Authorized to be charged to deposit account Enclosed	
City: Washington	None required (government interest not affecting title	
State: DC Zip: 20004	8. Payment Information	
Phone Number: (202) 739-3000		
Fax Number: (202) 739-3001	Deposit Account Number 50-0310	
Email Address: patents@morganlewis.com	Authorized User Name Robert J. Goodell	
9. Signature: Signature	March 12, 2009  Date	
Robert J. Goodell - 41,040	Total number of pages including cover	
Name of Person Signing	sheet, attachments, and documents:	

The Control of the State of the Control of the Cont

## **ASSIGNMENT**

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

Т	ELEVISION	
for which I/WE executed an application for Uniapplication for United States Letters Patent on		y herewith; or filed an
WHEREAS, LG Electronics Inc., a coraddress is 20 Yeouido-dong, Yeongdeungpo-guto as Assignee), is desirous of securing the entirapplication for United States Letters Patent on (application;	, Seoul, 150-721, Republic of Korea re right, title, and interest in and to th	, (hereinafter referred is invention, the
NOW THEREFORE, be it known that, from assignee is hereby acknowledged, I/WE, a and do hereby sell, assign, transfer, and set over MY/OUR entire right, title, and interest in and continuations thereof, and all Letters Patent of reissues thereof; and I/WE hereby authorize and the United States to issue all Letters Patent for accordance with the terms of this Assignment;	is assignor(s), have sold, assigned, tra r unto the assignee, its lawful success to this invention and this application, the United States which may be grant d request the Commissioner of Patent	ansferred, and set over, sors and assigns, and all divisions, and sed thereon, and all its and Trademarks of
AND, I/WE HEREBY further covenant communicate with assignee, its successors and invention and testify in any legal proceeding, si and deliver all papers that may be necessary or assignee, its successors and assigns, execute all all rightful oaths and generally do everything peand enforce proper patent protection for this invexpense incident to the execution of such paper	assigns, any facts known to ME/US and all lawful papers when called upon desirable to perfect the title to this in divisional, continuation, and reissue ossible to aid assignce, its successors vention in the United States, it being	respecting this on to do so, execute evention in said applications, make and assigns, to obtain understood that any
AND, I/WE HEREBY authorize and re		
and Power of Attorney in this application, to in 12MAR209 ) the filing date and application		
IN TESTIMONY WHEREOF, I/WE h	ave hereunto set our hand(s).	
Full Name of Sole or First Assignor LEE, Young A	Assignor's Signature	Date February 24, 2009
Address	V	Citizenship
301, 605-7, Yeoksam-dong, Gangnam-gu, Seoul, Full Name of Second Assignor	1, , , , , , , , , , , , , , , , , , ,	Republic of Korca
YANG, Hee Su	Assignor's Signature	Date February 24, 2009
Address 4th Fl., 43-5, Dongsung-dong, Jongno-gu, Scoul,	Korca	Citizenship Republic of Korea
Names of additional inventors attached Yes	□ No	

I-WA/1632828.2

REEL: 022442 FRAME: 0767

**PATENT** 

Full Name of Third Assignor HAN, Kyong Tae	Assignor's Signature	Date
Address	- Contraction of the second	February 24, 2009
103-1601, Geumho Eden Apt., 680-12, Dongsam	1(il)-dong, Yeongdo-gu, Busan, Korea	Citizenship Republic of Korca
Full Name of Fourth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Fifth Assignor	Assignor's Signature	Date
Address	<u> </u>	Citizenship
Full Name of Sixth Assignor	Assignor's Signature	Date
Address	.1	Citizenship
Full Name of Seventh Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eighth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Ninth Assignor	Assignor's Signature	Oate
Address		Citizenship
Full Name of Tenth Assignor	Assignor's Signature	Date
Address	<u></u>	Citizenship
Full Name of Eleventh Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached Yes	s ■No	

I-WA/1632828.2

**RECORDED: 03/12/2009** 

PATENT REEL: 022442 FRAME: 0768

. . :